# THE DENSITY-OF-STATE DISTRIBUTION IN UNDOPED a-Si:H AND a-SiGe:H DETERMINED BY HETEROJUNCTIONS WITH c-Si

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#### ABSTRACT

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A novel technique has been proposed for determining the density-of-state (DOS) distribution in the mobility gap of highly resistive amorphous semiconductors, using amorphous/crystalline heterojunction structures. This technique has been tested and applied on undoped a-Si:H and a-SiGe:H films, covering the optical gap (E<sub>0</sub>) range of 1.30 to 1.76 eV. For undoped a-Si:H with E<sub>0</sub>=1.76 eV, the peak of the midgap DOS distribution has been\_located at 0.85 eV below the conduction band edge, E<sub>0</sub>, with a value of 5.6x10<sup>-5</sup> cm<sup>-3</sup>eV<sup>-1</sup>. For undoped a-SiGe:H (E<sub>0</sub>=1.55 eV), the same has been obtained 0.71 eV below E<sub>C</sub>, with a magnitude of 7.9x10<sup>-5</sup> cm<sup>-3</sup>eV<sup>-1</sup>. Those midgap states have been found to be correlated with singly-occupied dangling bonds.

# INTRODUCTION

The electronic properties of hydrogenated amorphous silicon (a-Si:H) films are critically linked with the density and distribution of localized states in the mobility gap of a-Si:H. In order to enhance the performance of a-Si:H based devices, a low density-of-state (DOS) distribution, g(E), in the mobility gap, is essential. Measurement of g(E) and an understanding of the nature of the gap states are, therefore, very important. Many techniques have been developed to determine g(E). These include both optical and electrical methods (1,2), while they have some limitations in their application.

In the present work, we have focused on determining g(E) below the Fermi level ( $E_p$ ) in undoped a-Si:H films and also in undoped hydrogenated amorphous silicon-germanium alloy (a-SiGe:H) films. These films play an important role in enhancing the performance of amorphous solar cells. A few groups have sought to infer the energy location of the dangling bonds in a-SiGe:H (3-6).

Prior to this, the density of midgap states for undoped a-Si:H was obtained from the capacitance-voltage (C-V) characteristics of undoped (i.e., n-type) a-Si:H/p-type crystalline silicon (p c-Si) heterojunction structures under 100 kHz (7). This method will be called a steady-state heterojunctionmonitored capacitance (HMC) method in the following sections.

The steady-state HMC method has been applied to undoped a-SiGe:H with the optical gap (E<sub>0</sub>) between 1.30 and 1.70 eV. Moreover, it has been demonstrated that the g(E) below E<sub>F</sub> in amorphous films (1.30 eV  $\leq$  E<sub>0</sub>  $\leq$  1.76 eV) can be determined from the experimental results of transient HMC measurements.

### THEORY OF HETEROJUNCTION-MONITORED CAPACITANCE METHOD

#### Steady-state regime

The depletion region formed by an undoped a-Si:H (or a-SiGe:H)/p c-Si heterojunction is considered. When a reverse bias voltage (V<sub>R</sub>) is applied, it produces space-charge layers both in amorphous and crystalline semiconductors. Under the assumption that this p c-Si has only shallow acceptors, the space charge in the p c-Si formed by negatively-charged acceptors. However, the amorphous component possesses midgap states. Origin of the space charge in amorphous semiconductor, W the width of the depletion region, L<sup>g</sup> the thickness of the amorphous film, N<sub>A</sub> the acceptor density in the p c-Si, and V<sub>B</sub>

the built-in potential. The subscripts 1 and 2 refer to p c-Si and undoped films, respectively, and the subscripts C and V refer to the conduction band and the valence band, respectively. In the neutral region, all the gap states below  ${\rm E}_{\rm F}$  are occupied by electrons, while in the depletion region the states below  ${\rm E}_{\rm OB2}$  are occupied by electrons, where  ${\rm E}_{\rm OB2}$  is determined from the condition that the thermal-emission rate for electrons is equal to that for holes, and given by (8)

$$E_{OB2} = E_{C} - E_{g2}/2 + (kT/2) \ln(v_{p}/v_{n})$$
 (1)

Here  $v_1$  and  $v_p$  are the attempt-to-escape frequencies for electrons and holes, respectively. Therefore, the gap states as indicated by the black area in Fig. 1(a) behave like positively-charged states, here, referred to as donor-like states and the density of the donor-like states is constant between spatial position 0 and  $W_2$ . This together with the density of donors (if they exist) gives the effective density of donor-like states ( $N_1$ ), as shown in Fig. 1(c). Figure 1(b) shows the potential variation with distance. The depletion widths ( $W_1$  and  $W_2$ ) are given by

$$w_{1} = (2\varepsilon_{s1}(v_{B1} - v_{R1})/qN_{A})^{1/2} , \qquad (3)$$

$$W_2 \approx (2\epsilon_{s2}(V_{B2} - V_{R2})/qN_I)^{1/2}$$
 (4)

Here  $\boldsymbol{\epsilon}_{_{\mathrm{C}}}$  is the semiconductor permittivity.

The capacitance has been measured using a small AC voltage at 1 MHz. The resistivity ( $\rho_1$ ) of p c-Si used in this study is about 1  $\Omega$  cm so that the dielectric relaxation time ( $\epsilon_{s1}\rho_1$ ) becomes 10<sup>-12</sup> s. The capacitance (C<sub>1</sub>) at 1 MHz in the p c-Si is given by

$$C_1 = \varepsilon_{s1} / W_1 \qquad (5)$$

On the other hand, the minimum value of resistivity ( $\rho_2$ ) of undoped a-SiGe:H used is 10  $^{\circ}_{\Omega}$  cm. Then, the dielectric relaxation time becomes 10  $^{\circ}$  s. Thus, the undoped film may be considered as a dielectric material in its behavior in the case of the 1-MHz AC voltage, indicating that the capacitance (C\_2) at 1 MHz in the undoped films should be given by

$$C_2 = \varepsilon_{s2}/L \qquad . \tag{6}$$

p c-Si Amorphous Mg



## Fig. 1.

Schematic sketches of the heterojunction: (a) energy-band diagram; (b) potential variation; (c) space-charge density for  $V_{\rm R}$ ; (d) charge in response to a small 1-MHz AC voltage to measure capacitance. The gap states as indicated by the black area are positively-charged states, and the states as indicated by the hatched area are occupied by electrons. The measured HMC ( $\rm C_{HM}$ ) at 1 MHz is from a series of  $\rm C_1$  and  $\rm C_2,~$  and is expresses as

$$1/C_{\mu M} = 1/C_1 + 1/C_2$$
, (7)

because spatially the free charged carriers can respond to the 1-MHz AC voltage at W and L, as shown in Fig. 1(d). From Eqs. (2)-(4), the following relation is obtained;

$$(v_{B1} - v_{R1})/(v_{B2} - v_{R2}) \approx v_{I} \varepsilon_{s2}/v_{A} \varepsilon_{s1}$$
(8)

The final equation is obtained as

$$W_1^2 = \varepsilon_{s1}^2 (1/C_{HM} - 1/C_2)^2$$
(9)

$$\simeq 2\varepsilon_{sl}\varepsilon_{s2}N_{I}(V_{B} - V_{R})/qN_{A}(N_{A}\varepsilon_{s1} + N_{I}\varepsilon_{s2})$$
(10)

from Eqs. (3), (5), (7), and (8). As is clear from Eq. (10), the values of  $N_{I}$  and  $V_{B}$  can be graphically determined from the slope and the intercept on the abscissa, respectively.

#### Transient regime

In order to estimate g(E), the transient HMC is considered after  $V_{\rm R}$  is applied to the sample over the zero-bias condition  $(-t_{\rm f} \leq t^{<} 0)$ , as shown in Fig. 2. At t=+0,  $V_{\rm R}$  is applied across the whole of the amorphous and crystalline components. Electrons trapped at shallower states at t<0 get thermally emitted into the conduction band. After  $V_{\rm R}$  has been on for the dielectric relaxation time  $(\epsilon_{\rm g2}\rho_2)$  of the amorphous film, the space charge in the vicinity of the heterojunction will redistribute itself in response to the applied potential, as shown in Fig. 2(b). The data of  $C_{\rm HM}(t)$  after the dielectric relaxation time can be analyzed from Eq. (10) and  $N_{\rm I}$  at a time of t can expresses as

with 
$$N_{I}(t) = \epsilon_{s1}V_{c}(t)N_{A}/\epsilon_{s2}(V_{B} - V_{R} - V_{c}(t))$$
 (11)

$$V_{c}(t) = qN_{A}W_{1}^{2}(t)/2\epsilon_{s1}$$
 (12)

and

$$W_1(t) = \epsilon_{s1}(1/C_{HM}(t) - 1/C_2)$$
 (13)

where  $W_1(t)$  is the depletion width at time t and V(t) is the voltage across the depletion region of the p c-Si at t. In order to make the above analysis feasible, the absolute value of V<sub>R</sub> has to be necessarily much higher than V<sub>B</sub>, so that the relation (N<sub>I</sub>(t)W<sub>2</sub>(t)  $\gg$  N<sub>I</sub>( $\infty$ )W<sub>2</sub>(0) ) is valid and the average value



#### Fig. 2.

Schematic sketches (energy-band diagram and space-charge density) of the heterojunction at three times. The gap states as indicated by the hatched area are occupied by electrons, so that they are neutral. In the depletion region, therefore, the empty gap states between  $E_F$  and  $E_{OB2}$  behave as positively-charged states.

of  $N_{I}$  over the depletion region at t is close to  $N_{I}(t)$ . This condition also suggests that interface states do not affect the measurement of HMC.

The function H(t) is defined as

$$H(t) \equiv -t(d^{\Delta}N_{T}(t)/dt)$$
(14)

$$\Delta N_{I} \equiv N_{I}(t) - N_{I}(\infty) , \qquad (15)$$

and the measured H(t) is obtained from C<sub>HM</sub>(t) using Eqs. (11)-(14). The values of V<sub>B</sub> and C<sub>2</sub> have been obtained from steady-state HMC measurements. On the other hand, H(t) is theoretically derived as

 $H(t) = \int_{E_{V}}^{E_{C}} (f(E) - F_{\infty}(E))g(E)t(e_{n}(E) + e_{p}(E))exp(-(e_{n}(E) + e_{p}(E))t)dE$ (16)

with

$$f(E) = 1/(1 + \exp((E - E_F)/kT))$$
, (17)

 $F_{\infty}(E) = e_{n}(E)/(e_{n}(E)+e_{n}(E))$  , (18)

$$e_n(E) = v_n \exp((E - E_C)/kT)$$
 , (19)

 $e_{p}(E) = v_{p} \exp((E_{V}-E)/kT) \qquad (20)$ 

The way of determining g(E) from which H(t) of Eq. (16) can be obtained to fit the measured H(t), has been described in the section of results and discussion.

Under the condition that e (E)  $\ll$  e (E) and f(E)  $\simeq$  1 (i.e., for the gap states between E  $_{\rm F}$  and E  $_{\rm OB2}$ ), the relations

$$g(E(t)) = H(t)/kT$$
(21)  
and

$$E_{0}-E(t) = kT \ln(v_{t})$$
(22)

are obtained, which are similar to the relations obtained from the isothermal capacitance transient spectroscopy (ICTS) analysis (2).

# EXPERIMENT

Undoped a-Si:H films ( $E_0$ =1.76 eV) were deposited using a diode-type glow discharge reactor from pure SiH<sub>4</sub>, and undoped a-SiGe:H films ( $E_0$ =1.55, 1.63, 1.70 eV) were prepared using a triode-type glow discharge reactor from GeH<sub>4</sub>/SiH<sub>4</sub> gas mixture. Undoped a-SiGe:H films ( $E_0$ =1.30 eV) were deposited using a diode-type glow discharge reactor from H<sub>2</sub>/GeH<sub>4</sub>/SiH<sub>4</sub> gas mixture. Good quality films can be obtained from these techniques (9).

The heterojunctions were fabricated by depositing the amorphous films (thickness between 0.5 and 1  $\mu$ m) onto p c-Si substrates (N<sub>A</sub>=1x10<sup>16</sup> cm<sup>-3</sup>) heated to 250 °C and then evaporating magnesium (Mg) on an area (0.785 mm<sup>-2</sup>) of those films at room temperature. Mg forms an ohmic contact with those amorphous films (10). All the heterojunctions have exhibited good rectifying properties.

The C-V characteristics of those heterojunctions were measured at 1 MHz at room temperature. Detailed calculation of  $W_1$  was performed by the minicomputer. The transient capacitance,  $C_{HM}(t)_4$  was measured at 2 MHz under isothermal conditions in the time range of 10 -10 s, being converted to digital signals and memorized in the minicomputer. Detailed calculation of H(t) was performed by the minicomputer.

# RESULTS AND DISCUSSION Steady-state\_HMC measurements

Figure 3 shows the  $W_1^2$ -V curve obtained using Eq. (9) from  $C_{1M}$ -V characteristics of the a-SiGe:H ( $E_0$ =1.70 eV)/p c-Si heterojunction. The value of  $C_2$  which has been used to calculate  $W_1$  in Eq. (9) is the saturated capacitance with the forward bias. The data reveal a good linear relationship, indicating that the model mentioned in the previous section is applicable to the present system. As is clear from Eq. (10), values of  $N_1$ =6.3x10<sup>15</sup> cm<sup>-3</sup> and  $V_B$ =0.18 eV have been obtained from Fig. 3.

 $N_1=6.3 \times 10^{15}$  cm<sup>-3</sup> and  $V_p=0.18$  eV have been obtained from Fig. 3. It has been experimentally found that the  $W_1 - V_p$  relations for all the heterojunctions obey Eq. (10).  $N_1$  has been found to be independent of the thickness of the amorphous film. The dependence of  $N_1$  on  $E_0$  is shown in Fig. 4. These results remain unaffected at measuring frequencies higher than  $1/2\pi\epsilon_2\rho_2$ , where  $\rho_2$  depends on measuring temperature.

 $1/2\pi\epsilon_{p,\rho}$ , where  $\rho_{p,\rho}$  depends on measuring temperature. The bulk spin densities obtained from electron spin resonance (ESR) measurements are  $1.3 \times 10^{-1}$  and  $3.6 \times 10^{-1}$  cm<sup>-3</sup> for undoped a-SiGe:H (E<sub>0</sub>=1.30 eV) and undoped a-Si:H (E<sub>0</sub>=1.76 eV), respectively, and they are close to N<sub>1</sub>. Therefore, these results indicate that N<sub>1</sub> represents the density of singlyoccupied dangling bonds (D<sup>-</sup>). This optical-gap dependence of N<sub>1</sub> coincides with that of the integrated sub-bandgap absorption determined by constant photocurrent measurements (8, 11).





#### Transient HMC measurements

Transient capacitance,  $C_{HM}(t)$ , has been measured at various temperatures. Only signals of H(t) longer than the dielectric relaxation time are valid. The signals of H(t) get saturated at a filling time,  $t_r$ , (under the zero-bias condition) longer than 1 s, and they have been found to be independent of  $V_R \leq -3$  V. Therefore,  $C_{HM}(t)$  has been measured at  $t_r$ =50 s and  $V_R$ =4 V. The measured H(t) for the a-SiGe:H ( $E_0$ =1.70 eV)/p c-Si heterojunction at 353 K is shown in Fig. 5. From the temperature dependence of the time ( $t_p$ ) at





Fig. 5. Comparison between the measured and calculated H(t).



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which the signal of H(t) becomes maximum, a value of  $v_n = 8 \times 10^{11} \text{ s}^{-1}$  has been obtained using Eq. (22). The H(t) which has been calculated from Eq. (16) is shown in Fig. 5. Here the g(E) for  $E_0 = 1.70$  eV as shown in Fig. 6 has been used and  $v_p$  has been assumed to be  $1 \times 10^8 \text{ s}^{-1}$  (8). The calculated H(t) have been found to fit the measured H(t) very well at each temperature.

All the g(E) obtained from the fitting procedure are shown in Fig. 6. The values of v obtained from the temperature dependence of t are  $4x10^{12}$ ,  $1x10^{12}$ , and  $4x10^{11}$  s<sup>-1</sup> for E<sub>0</sub>=1.55, 1.63, and 1.76 eV, respectively, and these values have been used to determine g(E). These g(E) are correlated with D, as is clear from the results of steady-state HMC measurements.

Tsutsumi et al. (6) first determined the energy location of  $D^0$  in a-SiGe:H, while Mackenzie et al. (3), Skumanich et al. (4) and Aljishi et al. (5) discussed it in relation with their own experimental results. Our data coincide quantitatively with the data reported by Tsutsumi et al., although all the groups have reported the similar optical-gap dependence of the energy location of  $D^0$ . Using the transient HMC method, however, we have determine the magnitude as well as the location of  $D^0$  for the first time.

#### SUMMARY

The densities of midgap states of undoped a-SiGe:H and undoped a-Si:H have been determined using amorphous/crystalline heterojunction structures. These densities have been found to be independent of the measuring frequency as well as the measuring temperature when the measuring frequency is higher than  $1/2\pi\epsilon_{\rm S2}\rho_2$ . They have been found to be densities of singly-occupied dangling bonds in those materials. The DOS distributions for these films have been determined by transient HMC measurements which have been proposed.

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